

Electronic Patent Application Fee Transmittal

Application Number:	10598469			
Filing Date:				
Title of Invention:	Multilayer Substrate Manufacturing Method			
First Named Inventor/Applicant Name:	Takeshi Nakamura			
Filer:	Samuel Borodach/Gina Maldonado			
Attorney Docket Number:	14225-112US1 F1040898US00			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Late filing fee for oath or declaration	1051	1	130	130
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				130